CUSTOMER PRODUCT SPECIFICATION SHEET

.XX ± 0.15

.XXX ± 0.10

NOT TO SCALE

UNIT: mm

BOX HEADER

Drawn:

App'd:

Date:

CHC

XXXX

9 NOV. '15

Title

Revision: 1.9

RoHS Compliant

BB02-BY

of 1

E and 0 E

Drawing Number:

Sheet 1

Drawing (C)

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BB02-BY: - 1.27mm X 1.27mm (0.05" X 0.05") BOX HEADER, SMD, DUAL ROW - 10 TO 100 CONTACTS

SPECIFICATIONS :

CURRENT RATING 1 AMP

INSULATOR RESISTANCE 1000 MEGOHMS MIN.

DIFLECTRIC WITHSTANDING

AC 300 V 20m OHMS MAX.

CONTACT RESISTANCE

OPERATING TEMPERATURE

-40°C TO +105°C

CONTACT MATERIAL

BRASS

INSULATOR MATERIAL

THERMOPLASTIC UL 94V-0 STANDARD: LCP + 30% G/FA

PLATING.

GOLD OR TIN OVER 30~50U" NICKEL

SOLDERABILITY IR REFLOW: 280°C FOR 10 SEC

MANUAL SOLDER: 380°C FOR 3-5 SEC

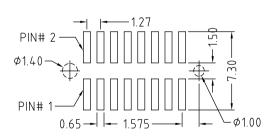
MATES WITH

PERFECT MATING PARTS: BB02-CM BB02-CU

OTHER MATING PARTS: BB02-CL, BB02-CN (4.40MM PROFILE ONLY)

NOTES:

- 1. MATING HEIGHTS:
- a). WITH INSULATION HEIGHT OF A=5.7MM. THE MATING HEIGHT IS 2.0MM+SOCKET HEIGHT.
- b). WITH INSULATION HEIGHT OF B=7.3MM. THE MATING HEIGHT IS 3.6MM+SOCKET HEIGHT.



RECOMMENDED PC BOARD SMD LAYOUT (TOLERANCE: ±0.05)

